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SPECIFICATION FOR APPROVAL

CUSTOMER	:	
PRODUCT TYPE	:	SMD SEAM SEALING X'TAL 2.0 × 1.6
NOMINAL FREQ.	:	16.00000MHz
TXC P/N	:	8Y16070019
REVISION	:	S3
CUSTOMER P/N	:	
PM / SALES	:	
DATE	:	
CUSTOMER SIGNA	TU	RE & Date
	•	
	•	

- (1) TXC requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.
- (2) Orders received and accepted by TXC after return of signed copy of specification will be produced per these specifications.
- (3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.
- (4) Any issuance of purchase order prior to consigning back the Approval page of "Specification Sheets" from customers will be regarded as the agreement on the contents of these specifications.

Attachment: Product Specification Sheet

- 1
- 2
- 3
- 4
- 5

RoHS Compliant



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PRODUCT SPECIFICATION SHEET

PRODUCT TYPE : SMD SEAM SEALING X'TAL 2.0 × 1.6

NOMINAL FREQ. : 16.000000MHz

TXC P/N : 8Y16070019

REVISION : S3

PE/RD	QA	MFG
Dobin Huang Robin Huang		
17-Ғеб-17		

NOTE:

(1)The green product standard set by TXC is based upon the international standards. Related information is publicly described on the TXC's Website, and updated regularly. The document is compliant with the latest green product quality system directives at the time.

(2)Revision "Sx" is for engineering samples only. PE/RD's approval required.

(3) Revision "Ax" is production ready. PE, QA and MFG's approval required

RoHS Compliant



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Rev	Revise page	Revise contents	<u>Date</u>	Ref.No.	Reviser
S1	N/A	Initial released	16-Jan-17	N/A	Xiaoyan Jiang
S2	3	Load Capacitance 12pF Change To 10pF	8-Feb-17	PNR17020401	Xiaoyan Jiang
S3	3	Load Capacitance 10pF Change To 12pF	17-Feb-17	PNR17021401	Xiaoyan Jiang

Spec Sheet Contents

No.	Content	Page
1	ELECTRICAL SPECIFICATIONS	P.3
2	DIMENSIONS	P.4
3	MARKING	P.4
4	FACTORY LOCATION	P.4
5	SUGGESTED REFLOW PROFILE& MANUAL SOLDER CONDITION	P.4
6	STRUCTURE ILLUSTRATION	P.5
7	EMBOSS CARRIER TAPE & REEL	P.6
8	PACKING	P.7
9	RELIABILITY SPECIFICATIONS&HANDING CAUTIONS	P.8~9

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■ ELECTRICAL SPECIFICATIONS

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature : $25\pm10^{\circ}$ C Relative humidity : $40\%\sim70\%$

If there is any doubt about the results, measurement shall be made within the following limits:

Ambient temperature : $25\pm3^{\circ}$ C Relative humidity : $40\%\sim70\%$

Measure equipment

Electrical characteristics measured by S&A250B or equivalent.

Crystal cutting type

The crystal is using AT CUT (thickness shear mode).

Unit Weight:

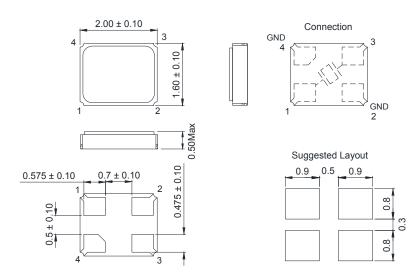
0.005±0.002 g/pcs

	Parameters	Symbol	Electrical Spec.				Notes	
	Parameters		Min.	Тур.	Max.	Units	Notes	
1	Nominal Frequency	FL	1	16.000000	0	MHz	-	
2	Oscillation Mode	-	Fı	undament	tal	-	-	
3	Load Capacitance	CL		12		pF	-	
4	Frequency Tolerance	-		±20		ppm	at 25 ℃ ± 3 ℃	
5	Frequency Stability	-	±25		ppm	Over Operating Temp. Range (Reference 25° C)		
6	Operating Temperature	-	-40	~	85	$^{\circ}\!\mathbb{C}$	-	
7	Aging	-		±3		ppm	1st Year	
8	Drive Level	DL	-	10	100	uW	-	
9	Equivalent Series Resistance	Rr	-	ı	100	Ω	-	
10	Shunt Capacitance C0	C0	-	-	2	pF	-	
11	Insulation Resistance	-	500	ı	-	ΜΩ	at DC 100V	
12	Storage Temperature Range	-	-40	~	125	$^{\circ}\!\mathbb{C}$	-	

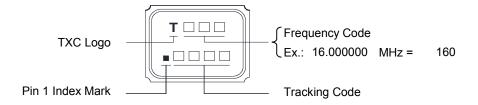
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DIMENSIONS

(Unit:mm)



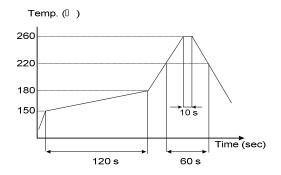
MARKING



Production Location: Taiwan, China(Ningbo)

■ SUGGESTED REFLOW PROFIL

Total time : 200 sec. Max. Solder melting point :220 $^{\circ}$



■ SUGGESTED MANUAL SOLDER CONDITION

Temperature: 350 \pm 10 $^{\circ}$ C

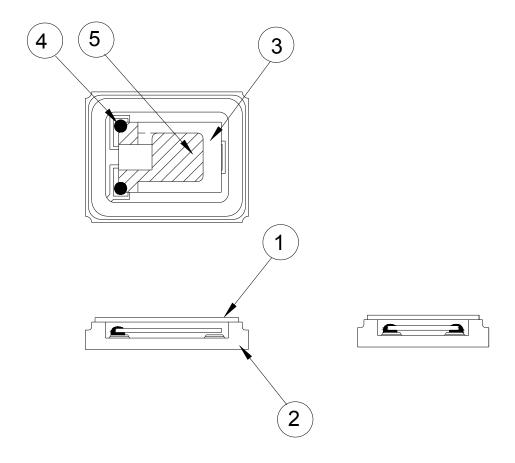
Time: 3 sec.

Re-solder times: twice



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■ STRUCTURE ILLUSTRATION

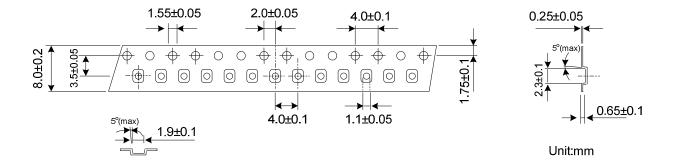


NO	COMPONENTS	MATERIALS	FINISH/SPECIFICATIONS
1	Lid	Kovar (Fe/Co/Ni)	-
2	Base(Package)	Ceramic (Al ₂ O ₃) + Kovar (Fe/Co/Ni)+Pad(Au)	Tungsten metalize + Ni plating + Au plating
3	Crystal blank	SiO ₂	-
4	Conductive adhesive	Resin+Ag	-
5	Electrode	Noble Metal	-

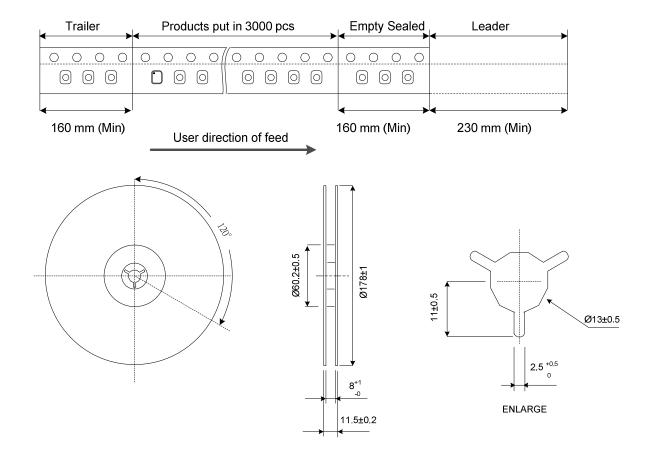


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PACKING



REMARK:



Standard Reel Quantity is 3,000 pcs per reel

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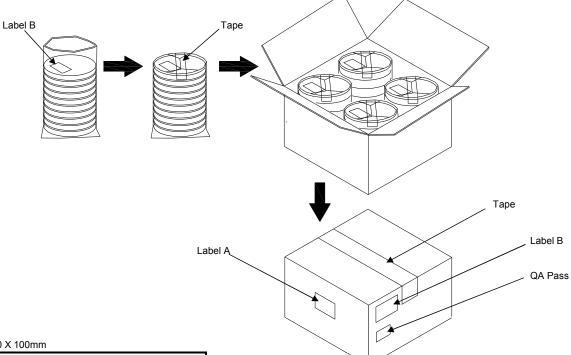
PACKING

Reel Quantity:

- 1. Reel X 6 (6 Reels)
- 2. Reel X 12 (12 Reels) 3. Reel X 25 (12 Reels + 13 Reels)
- 4. Reel X 50 (12 Reelsx2 + 13 Reelsx2)

Box Size:

- 1. L200 X W200 X H140mm
- 2. L200 X W200 X H250mm
- 3. L400 X W200 X H250mm
- 4. L400 X W400 X H280mm



(Label A) Size:100 X 100mm

Inv No: -----

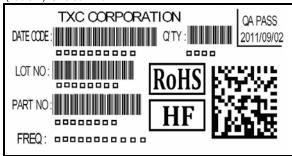
Po No: **DDDDDDD**

Part No:

Q'ty:

C/No: 0000

(Lable B) Size:80 X 40mm



[STORAGE]

- 1.Don't be caught in the rain.
- 2.The storage environment shall be 5 $^{\circ}$ C $^{\sim}$ 40 $^{\circ}$ C temperature and 30% $^{\sim}$ 75%RH humidity and free from the sun shine.
- 3.If customers have special requirements, we can paste labels according to it.



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■ RELIABILITY SPECIFICATIONS

1.Mechanical Endurance

No.	Test Item	Test Me	Test Criteria	
1	Drop Test	150 cm height, 3 times on concrete	A.C	
1	Mechanical Shock	Device are shocked to half sine wa	A 6	
'	iviechanicai Shock	perpendicular axes each 3 times. 0	.5m sec. duration time	A . C
		Frequency range	10 ~ 2000 Hz	
		Amplitude	1.52 mm/20G	
1	Vibration	Sweep time	20 minutes	A . C
		perpendicular axes each test time	4 Hrs	
			(Total test time 12 Hrs)	
1	Gross Leak	Standard Sample For Automatic Gross Leak Detector, Test Pressure: 2kg / cm ²		F
2	Fine Leak	Helium Bombing 4.5 kg/ cm ² for 2 Hrs		G
		Temperature	240 °C ± 5°C	
	2 Solder ability	Immersing depth	0.5 mm minimum	
2		Immersion time	5 ± 1 seconds	E
		Flux	Rosin resin methyl alcohol	
			solvent (1:4)	

2. Environmental Endurance

No.	Test Item	Test Methods	Test Criteria
2	Resistance To Soldering Heat	Pre-heat temperature $125 ^{\circ}\text{C}$ Pre-heat time $60 ^{\circ}$ 120 sec.Test temperature $260 \pm 5 ^{\circ}\text{C}$ Test time $10 \pm 1 \text{sec.}$	B.C.D
2	High Temp. Storage	+ 125 °C ± 3 °C for 500 ± 12 Hrs	B.C.D
2	Low Temp. Storage	- 40 °C ± 3 °C for 500 ± 12 Hrs	B : O : B
2	Temperature cycle	Total 100 cycles of the following temperature cycle $\begin{array}{c ccccccccccccccccccccccccccccccccccc$	B.C.D
3	High Temp & Humidity	85°C ± 3°C, RH 85% , 500Hrs	B . C . D

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RELIABILITY SPECIFICATIONS

	Specifications
А	Frequency change: Within ±5ppm or in customer's specification.
В	Frequency change: Within ±10ppm or in customer's specification.
С	Equivalent series resistance(E.S.R) change: Within ±15% or 10Ω(larger value).
D	After conditioning , quartz crystal units shall be subjected to standard atmospheric conditions for 2 hour, and measured.
Е	Minimum 95% of immersed terminal shall be covered with new uniform solder.
F	Leak rate< 1×10 ⁻⁵ Pa*m³/Sec
G	Leak rate< 4×10 ⁻⁹ Pa*m³/Sec

Measurement condition

Electrical characteristics measured by S&A250B or equivalent.